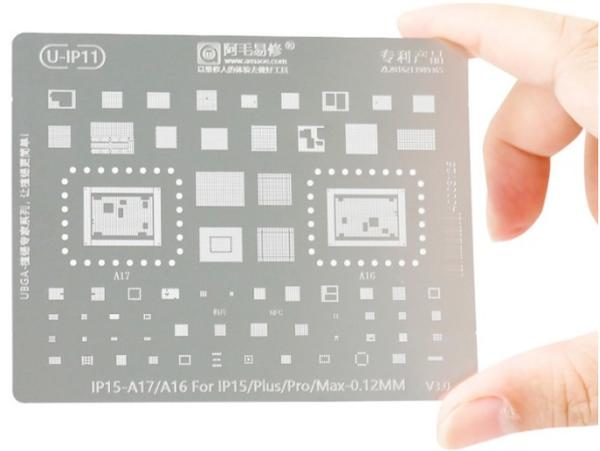# CPU Solder Implant Network

◆ Product Description

CPU solder implantation dedicated tool, precisely drills holes according to chip model, can quickly locate solder paste, ensure uniform solder implantation, increase the success rate of chip repair, and is compatible with multiple models.

◆ Product Advantages

• The hole positions are precise without any deviation
• Uniform and efficient tin planting
• Resistant to high temperatures without deformation
• Wide model compatibility
• Increase the success rate of maintenance

◆ Technical Features

Model: U-IP11 The material is stainless steel. The openings are precisely matched with the CPU model. It is heat-resistant and wear-resistant. The mesh surface is smooth. The tin planting is not easy to shift and can be reused repeatedl.

◆ Product Structure

Made of 304 stainless steel, it is etched and formed. The mesh surface is flat without protrusions. The holes are precisely arranged and of uniform size. The edges are reinforced to prevent deformation. Precise alignment and tin placement are carried out.

tem Code (SKU)	Weight (kg)	Packing Detail
1.5.19.03.0016	0.0083	1pc/box

◆ Application Scenarios

It is used for the repair of CPU chips in mobile phones and computers, tin planting and soldering after chip desoldering, and is suitable for scenarios such as chip inspection in repair shops, motherboard refurbishment, and electronic equipment fault repair.

◆ Remarks

HORB has a technical hotline for technical and usage inquiries. This information is deemed accurate, for professional end users only. HORB data is for reference.
KANBO is a registered trademark of HORB®. All

HORB Group
www.horbmall.com

6-7/F, Bldg B, Funing Hi-Tech Park, No.71-2 Xintian Blvd, Fuyong, Bao'an, Shenzhen
Email : service@horb.com.cn   Service Hotline : 0755-2946 1997